



1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

PowerDI®123

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead Free Finish, RoHS Compliant (Note 4)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI®123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208@3
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.096 grams (approximate)



Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Forward Current @ T _T = 120°C	I _{F(AV)}	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	1.67	W
Power Dissipation (Note 2)	P_{D}	556	mW
Thermal Resistance Junction to Soldering Point (Note 3)	$R_{ heta JS}$	10	°C/W
Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	60	°C/W
Thermal Resistance Junction to Ambient (Note 2)	$R_{\theta JA}$	180	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

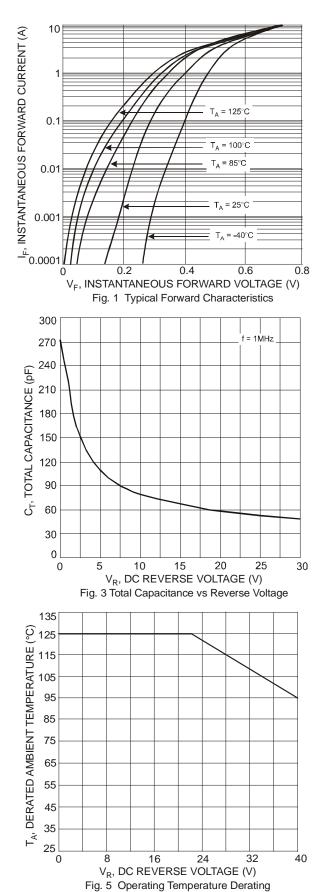
Electrical Characteristics @T_A = 25°C unless otherwise specified

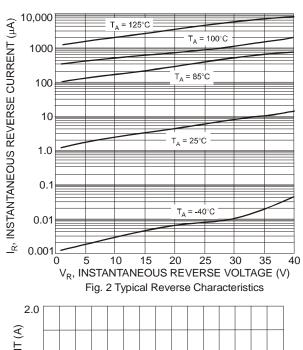
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	40	1	_	V	$I_R = 500 \mu A$
Forward Voltage	V _F			0.36 0.30 0.55 0.515	V	I _F = 0.1A, T _J = 25°C I _F = 0.1A, T _J = 85°C I _F = 1.0A, T _J = 25°C I _F = 1.0A, T _J = 85°C
				0.85 0.88		I _F = 3.0A, T _J = 25°C I _F = 3.0A, T _J = 85°C
Leakage Current (Note 5)	I _R		_	0.5 25	mA	$V_R = 40V, T_J = 25^{\circ}C$ $V_R = 40V, T_J = 85^{\circ}C$
-coalage carroin (riote of				0.15 18		$V_R = 20V, T_J = 25^{\circ}C$ $V_R = 20V, T_J = 85^{\circ}C$
Total Capacitance	C _T	_	55	_	pF	$V_R = 10V, f = 1.0MHz$

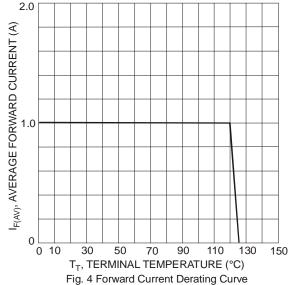
Notes:

- 1. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode. TA = 25°C
- 2. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads.T_A = 25°C
- 3. Theoretical $R_{\theta JS}$ calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- Short duration pulse test to minimize self-heating effect.











Ordering Information (Note 6)

Part Number	Case	Packaging
DFLS140L-7	PowerDI [®] 123	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



F06 = Product Type Marking Code YM = Date Code Marking

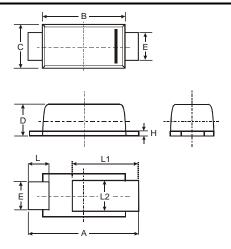
Y = Year (ex: T = 2006)

M = Month (ex: 9 = September)

Date Code Key

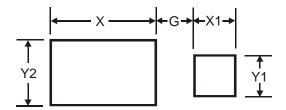
Year	2004	20	05	2006	2007	20	800	2009	2010	20	11	2012
Code	R		3	T	U	,	V	W	X	`	Y	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Package Outline Dimensions



PowerDI [®] 123					
Dim	Min	Max	Тур		
A	3.50	3.90	3.70		
В	2.60	3.00	2.80		
С	1.63	1.93	1.78		
D	0.93	1.00	0.98		
Е	0.85	1.25	1.00		
Н	0.15	0.25	0.20		
L	0.55	0.75	0.65		
L1	1.80	2.20	2.00		
L2	0.95	1.25	1.10		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.

PowerDI is a registered trademark of Diodes Incorporated.